

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
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XIN SUN	11/15/2022
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Property Type	Number
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DATE SIGNED:	11/16/2022
Total Attachments: 1	
source=Q260357ExecutedDocumentaryEvidenceofOwnership#page1.tif	

Documentary Evidence of Obligation to Assign Invention

The inventor listed below for U.S. Patent Application 17/185,002, was an employee of TENCENT TECHNOLOGY (SHENZHEN) COMPANY LIMITED (35/F, Tencent Building, Kejizhongyi Road, Midwest District of Hi-tech Park, Nanshan District, Shenzhen, Guangdong, 518057, China) at the time of the invention reflected in the listed application, and was under obligation to assign his invention to TENCENT TECHNOLOGY (SHENZHEN) COMPANY LIMITED (35/F, Tencent Building, Kejizhongyi Road, Midwest District of Hi-tech Park, Nanshan District, Shenzhen, Guangdong, 518057, China).

Chen Xingjian

NOV. 15, 2022

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Title

Manager of Foreign Patent Filing Department

TENCENT TECHNOLOGY (SHENZHEN) COMPANY LIMITED
Company

Matter No.
Q260357

Inventor
Xin SUN

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